SHEET 1 OF 9 ATTY, DOCKET NO. SERIAL NO. INFORMATION DISCLOSURE 14912.786 CITATION 10/053,138 APPLICANT Stephen E. Savas PTO-1449 **GROUP 1763** FILING DATE 01/18/2002 U.S. PATENT DOCUMENTS **CLASS EXAMINER'S** PATENT NO. DATE · NAME **SUBCLASS** FILING DATE **INITIALS** 5,571,366 11/1996 Ishii et al. 156 345 pt 07/1992 Blalock 723I 5,647,913 118 . ph 09/1996 Okumura et al. 118 723I 5,558,722 121 09/1996 204 192.37 Ghanbari 5,556,521 p L 09/1995 Hanaw 156 643.1 5,449,432 pL 315 12/1997 Pasch 111,21 5,696,428 ρL 11/1997 345 5,690,781 Yoshida et al. 156 pL 5,401,350 03/1995 Patrick et al. 156 345 PL 6,068,784 05/2000 Collins et al. 118 723I FOREIGN PATENT DOCUMENTS PATENT NO. DATE COUNTRY **CLASS** SUBCLASS TRANSLATION **EXAMINER'S INITIALS** YES NO pL C08 J7/00 2 105 729 A 30.03.83 Great Britain C08F 2/52 pl 408288272 11/1996 C23C 16/50 Japan pI 0154482A2 11/1985 Europe C23C 16/00 pl 2240114A 07/1991 -Great Britain C23C 16/26 OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.) R.W. Boswell et al., "Pulsed high rate plasma etching with variable Si/SiO2 selectivity and variable Si etch pL profiles," Appl. Phys. Lett. 47 (10), 15 Nov. 1985, pp. 1095-1097 J. Pope et al., "A Highly Selective Nitride to Oxide Etch to Reduce Single Bit Failures on Memory pL Products," Electrochemical Society Proceedings, Vol. 93-21, 1993, pp. 168-234 PCT International Search Report dated 07 MAR 1997 of corresponding PCT Application No. ph PCT/US96/16138, references cited above. 5-25-03 P. Hasson Zadil DATE CONSIDERED **EXAMINER**

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EXAMINER'S	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING	DATE	
INITIALS	5,811,022	09/22/1998	Savas et al.	216	68	11/15/1	994	
pL	5,534,231	07/09/1996	Savas	216	67	01/17/1	995	
p L	5,419,805	05/30/1995	Jolly	156	643.1	02/18/1	994	
	5,399,237	03/21/1995	Keswick et al.	156	643	01/27/1	994	
PL PL	5,362,358	11/08/1994	Yamagata et al.	156	643	05/14/1	993	
	5,354,417	10/11/1994	Cheung et al.	156	643	10/13/1993		
PL PL	5,354,381	10/11/1994	Sheng	118	723	05/07/1993		
PL	5,344,792	09/06/1994	Sandhu et al.	437	200 03/0		03/04/1993	
ph.	5,332,441	07/26/1994	Barnes et al.	118	723	10/31/1991		
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pt			measurements and etching in a pr		ver inductively co	mbreg		
<u>'</u>			ources Sci. Technol. 5, p. 139 (19		ovugen helicar di	ffision		
ph			steady-state, and decay regimes i	in puised	ovaken nencon di	11091011		
	plasmas," J. App			lican di	ingion pleems " A	nnly Phy	g .	
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EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLA	ASS	SUBCLASS		DATE			
pt	5,318,668	06/07/1994	Tamaki et al.	156		662	10/20/1				
ph	5,318,664	06/07/1994	Saia et al.	156		643	11/14/1	991			
pk	5,312,518	05/17/1994	Kadomura	156		662	05/29/1	.992			
PL	5,310,452	05/10/1994	Doki et al.	156		643	07/20/1992				
ps	5,289,010	02/22/1994	Shohet	250		492.21	12/08/1992				
pt	5,286,344	02/15/1994	Blalock et al.	156	657		06/15/1992				
PF	5,286,297	02/15/1994	Moslehi et al.	118		723 E	06/24/1992				
ph	5,284,549	02/08/1994	Barnes et al.	156		662	01/02/1992				
12	5,259,924	11/09/1993	Mathews et al.	156		653	04/08/1992				
	<u>.L.,</u>	FORI	EIGN PATENT DOCUMENTS								
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w.L	X. Chen et al., "	Pulse plasma p	solymerization of tetramethyltin: 1	Vanos	ale c	ompositional co	ntrol of				
12.2	film chemistry,"	film chemistry," Chem. Mater. 8, p. 1067 (1996).									
PL	K. Hashimoto et	al., "Reductio	n of the charging damage from ele	ectron	shadi	ng," 1996 1st					
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pŁ	M.A. Lieberman	et al., "Globa	l models of pulse-power-modulate	ed high	dens	sity, low pressur	re				
p+	discharges," Plan	sma Sources S	ci. Technol. 5, p. 145 (1996).			<u>.</u>					
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EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLA	ASS	SUBCLASS	FILING	DATE		
PL	5,242,538	09/07/1993	Hamrah et al.	156		643	01/29/1	992		
12 L	5,234,529	08/10/1993	Johnson	156		345	10/10/1	991		
pl	5,231,057	07/27/1993	Doki et al.	437		225	08/20/1	.991		
101	5,227,331	07/13/1993	Westmoreland	437		174	02/10/1	992		
101	5,219,485	06/15/1993	Wang et al.	252		79.3	10/17/1991			
p.1	5,217,567	06/08/1993	Cote et al.	156		643		992		
p.L	5,201,994	04/13/1993	Nonaka et al.	156		643	11/17/1989			
pt	5,188,704	02/23/1993	Babie et al.	156		643		991		
12/	5,160,408	11/03/1992	Long	156	56 656 .		04/27/1990			
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ph	Y. Lin et al., "No	gative and pos	sitive ions from CF ₄ /O ₂ RF discha	rges in	etchi	ng Si," Appl. F	hys. Let	i.		
<i>l'</i>	62, p. 675 (1992).								
p.L	M. Moisan et al.	"Radio freque	ency or microwave plasma reactor	rs? Fac	ctors d	etermining the	optimun	n		
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pL	5,153,442	10/06/1992	Bovino et al.	250	551	01/03/	1991				
pL	5,112,435	05/12/1992	Wang et al.	156	643	11/29/	1989				
p.f	5,108,542	04/28/1992	Lin	156	643	08/23/	1990				
PL	5,007,982	04/16/1991	Tsou	156 .	643	07/11/	1988				
p1	4,994,715	02/19/1991	Asmus et al.	315	111.71	07/21/	07/21/1988				
pL	4,933,300	06/12/1990	Koinuma et al.	437	110	02/12/1988					
pl	4,985,112	01/15/1991	Egitto et al.	156	643	02/09/1987					
pl	4,970,435	11/13/1990	Tanaka et al.	315	111.21	12/08/1988					
pl	4,935,661	06/19/1990	Heinecke et al.	313	231.31	06/26/1	986				
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ph	discharges," J. A	discharges," J. Appl. Phys. 66, p. 1622 (1989).									
pL	L.J. Overzet, "M	odel for charge	movement after the radio frequen	ncy exci	tation is extinguish	ed," J. V	ac.				
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pt.	L.J. Overzet et al	., "Modeling a	nd measurements of the negative	ion flux	from amplitude mo	dulated	rf				
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		U.S	. PATENT DOCUMENTS			*	
EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLAS	SS SUBCLASS	FILING	DATE
pl	4,918,031	04/17/1990	Flamm et al.	437	225	12/28/1	988
ph	4,897,365	01/30/1990	Baldi et al.	437	69	11/23/1	1987
pL	4,891,118	01/02/1990	Ooiwa et al.	204	298	11/23/1	1988
pL	4,863,549	09/05/1989	Grünwald	156	345	07/01/3	1988
101	4,857,140	08/15/1989	Loewenstein	156	643	03/31/1988	
ph	4,836,887	06/06/1989	Daubenspeck et al.	156	643	11/23/1987	
j) L	4,836,886	06/06/1989	Daubenspeck	156	643	11/23/1987	
pk	4,824,690	04/25/1989	Heinecke et al.	427	38	11/03/1987	
pL	4,807,016	02/21/1989	Douglas	357	67	11/20/1987	
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01	L.J. Overzet et al	., "Negative a	nd positive ions from radio freque	ncy plas	mas in boron trichl	oride,"	
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n/	L.J. Overzet et al	., "Time-resol	ved power and impedance measur	ements	of pulsed radio freq	luency	
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pt	selective, highly 3398 (1994).	anisotropic, an	d notch-free polycrystalline silico	n patter	ning," Appl. Phys.	Lett. 64,	p,
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pt	4,793,897	12/27/1988	Dunfield et al.	156	643	03/20/	1987			
pl	4,749,589	06/07/1988	Heinecke et al.	427	39	12/10/	1985			
pL	4,734,157	03/29/1988	Carbaugh et al.	156	643	03/18/	1987			
PL	4,717,447	01/05/1988	Dieleman et al.	156	643	10/31/1983				
pl	4,693,805	09/15/1987	Quazi	204	192,22	02/14/1986				
12.1	4,654,114	03/31/1987	Kadomura	156	643	12/16/1985				
pL	4,585,516	04/29/1986	Corn et al.	156	643	03/04/1985				
pt	4,568,563.	02/04/1986	Jackson et al.	427	40	06/21/1985				
pl	4,263,088	04/21/1981	Gorin	156	626	06/25/1979				
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PL	4,180,432	12/25/1979	Clark	156	643	12/19/1	977			
PL	4,075,583	02/21/1978	Kershaw	333	73 R	05/24/1	976			
pL	3,940,506	02/24/1976	Heinecke	427	38	05/03/1	974			
12	4,568,410	02/04/1986	Thornquist	156	643	12/20/1	984			
121	4,412,119	10/25/1983	Komatsu et al.	219	121 PF	05/05/1	981			
ph	4,401,507	08/30/1983	Engle	156	643	07/14/1982				
PL	4,283,249	08/11/1981	Ephrath	156	643	08/17/1979				
pl	5,983,828	11/1999	Savas	118	7231					
pL	4,500,563	02/19/1985	Ellenberger et al.	427/.	38 427/39					
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pL	H. Sugai et al., "	Diagnostics an	d control of radicals in an inducti	vely co	upled etching reacto	r," J. Va	c.			
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pL	5,514,603	05/07/1996	Sato	437	16	05/06/	1994		
PL	5,928,528	07/27/1999	Kubota et al.	216	67	09/02/	1997		
p1	6,231,777	05/15/2001	Kofuji et al.	216	71	10/26/	1995		
pL	6,395,641	05/28/2002	Savas	438	714	05/16/2001			
pt	6,253,704	07/03/2001	Savas	188	723 I	09/17/1999			
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121	J.T. Verdeyen et	al., "Modulate	d discharges: effect on plasma	oarameters an	d deposition," J	. Vac.			
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